SHARP

# GP2L20L/GP2L20R

#### **■** Features

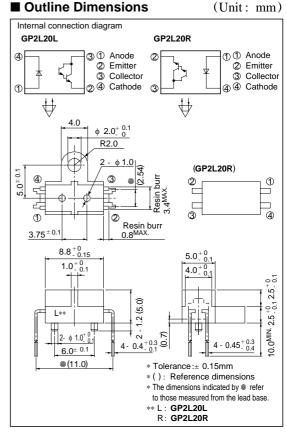
- 1. Correspond to DAT prism system
- 2. Compact and thin

## ■ Applications

1. Digital audio tape recorder

## Compact, Thin Type **Photointerrupter**

#### **■** Outline Dimensions



## ■ Absolute Maximum Ratings

/ TD		250	$\sim$
(Ia	_	''	C
$\mathbf{v}$	_	۷.)	

	Parameter	Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	*1Peak forward current	$I_{FM}$	1	A
	Reverse voltage	$V_R$	6	V
	Power dissipation	P	75	mW
	Collector-emitter voltage	V <sub>CEO</sub>	35	V
0	Emitter-collector voltage	V <sub>ECO</sub>	6	V
Output	Collector current	$I_{\rm C}$	20	mA
	Collector power dissipation	Pc	75	mW
	Operating temperature	T opr	- 25 to + 85	°C
Storage temperature *2Soldering temperature		T stg	- 40 to + 100	°C
		T sol	260	°C

<sup>\*1</sup> Pulse width<=100 \mu s, duty ratio= 0.01

<sup>\*2</sup> For 5 seconds

## **■** Electro-optical Characteristics

 $(Ta = 25^{\circ}C)$ 

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		VF	$I_F=20mA$	-	1.2	1.4	V
	Peak forward voltage		$V_{\text{FM}}$	$I_{\text{FM}} = 0.5A$	-	3	4	V
	Reverse current		$I_R$	$V_R = 3V$	-	-	10	μΑ
Output	Collector dark current		I <sub>CEO</sub>	$V_{CE} = 10V$	-	-	1 x 10 -6	A
Transfer characteristics	*3Collector current		$I_{\mathrm{C}}$	$V_{CE} = 5V$ , $I_F = 20mA$	1	-	20	mA
	Respons time	Rise time	$t_{\rm r}$	$V_{CE} = 2V$ , $I_C = 2mA$	-	80	400	μs
		Fall time	$t_{\mathrm{f}}$	$R_{\rm L}=100\Omega$	-	70	350	μs
	*4Leak current		ILEAK	$V_{CE}=5V,I_F=20mA$	-	-	5	μΑ

<sup>\*3</sup> The condition and arrangement of the reflective object are shown in the right drawing.

**Test Condition and Arrangement** for Collector Current

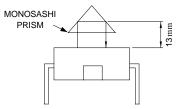


Fig. 1 Forward Current vs.
Ambient Temperature

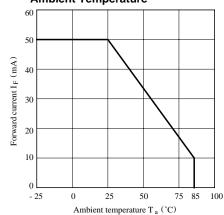
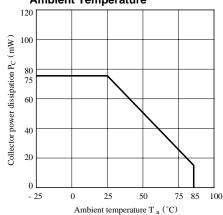


Fig. 2 Collector Power Dissipation vs.
Ambient Temperature



<sup>\*4</sup> Without reflective object

Fig. 3 Peak Forward Current vs. Duty Ratio

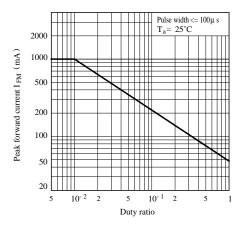


Fig. 5 Collector Current vs. Forward Current

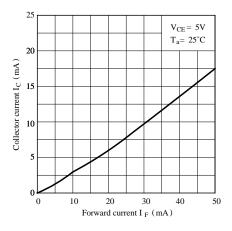


Fig. 7 Relative Collector Current vs.

Ambient Temperature

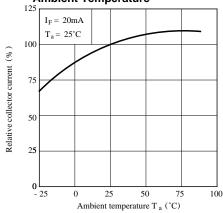


Fig. 4 Forward Current vs. Forward Voltage

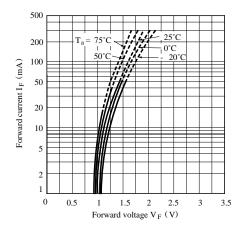


Fig. 6 Collector Current vs.
Collector-Emitter Voltage

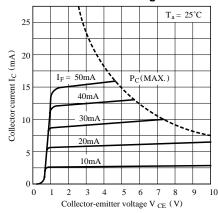
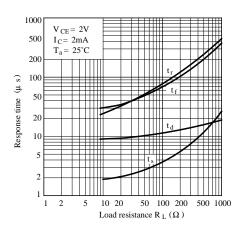


Fig. 8 Response Time vs. Load Resistance



### **Test Circuit for Response time**

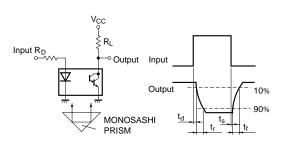
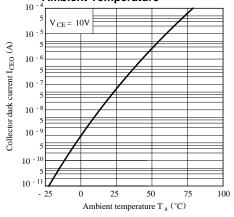
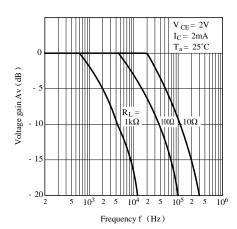


Fig.10 Collector Dark Current vs.
Ambient Temperature



• Please refer to the chapter "Precautions for Use".

Fig. 9 Frequency Response



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  - Gas leakage sensor breakers
  - Alarm equipment
  - Various safety devices, etc.
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